

# High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.58 \text{ V}$  at  $I_F = 5 \text{ A}$



## FEATURES

- Very low profile - typical height of 1.3 mm
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

AUTOMOTIVE  
GRADE  
Available



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## ADDITIONAL RESOURCES



## TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

## MECHANICAL DATA

**Case:** SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

| PRIMARY CHARACTERISTICS                                  |                     |
|----------------------------------------------------------|---------------------|
| $I_{F(AV)}$                                              | 40 A                |
| $V_{RRM}$                                                | 200 V               |
| $I_{FSM}$                                                | 240 A               |
| $V_F$ at $I_F = 20 \text{ A}$ ( $T_J = 125 \text{ °C}$ ) | 0.75 V              |
| $T_J$ max.                                               | 175 °C              |
| Package                                                  | SlimDPAK (TO-252AE) |
| Circuit configuration                                    | Common cathode      |

| MAXIMUM RATINGS ( $T_A = 25 \text{ °C}$ unless otherwise noted)                              |             |                   |      |
|----------------------------------------------------------------------------------------------|-------------|-------------------|------|
| PARAMETER                                                                                    | SYMBOL      | V40PW22C          | UNIT |
| Device marking code                                                                          |             | V40PW22C          |      |
| Maximum repetitive peak reverse voltage                                                      | $V_{RRM}$   | 200               | V    |
| Maximum average forward rectified current (fig. 1)                                           | per device  | $I_{F(AV)}^{(1)}$ | A    |
|                                                                                              | per diode   | $I_{F(AV)}^{(1)}$ | A    |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode | $I_{FSM}$   | 240               | A    |
| Operating junction temperature range                                                         | $T_J^{(2)}$ | -40 to +175       | °C   |
| Storage temperature range                                                                    | $T_{STG}$   | -55 to +175       | °C   |

## Notes

(1) With infinite heatsink

(2) The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta JA}$

**ELECTRICAL CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                             | TEST CONDITIONS        |                         | SYMBOL                        | TYP.   | MAX. | UNIT |
|---------------------------------------|------------------------|-------------------------|-------------------------------|--------|------|------|
| Maximum instantaneous forward voltage | I <sub>F</sub> = 5.0 A | T <sub>J</sub> = 25 °C  | V <sub>F</sub> <sup>(1)</sup> | 0.74   | -    | V    |
|                                       | I <sub>F</sub> = 10 A  |                         |                               | 0.8    | -    |      |
|                                       | I <sub>F</sub> = 20 A  |                         |                               | 0.89   | 0.97 |      |
|                                       | I <sub>F</sub> = 5.0 A | T <sub>J</sub> = 125 °C |                               | 0.58   | -    |      |
|                                       | I <sub>F</sub> = 10 A  |                         |                               | 0.65   | -    |      |
|                                       | I <sub>F</sub> = 20 A  |                         |                               | 0.75   | 0.83 |      |
| Reverse current                       | V <sub>R</sub> = 160 V | T <sub>J</sub> = 25 °C  | I <sub>R</sub> <sup>(2)</sup> | 0.0007 | -    | mA   |
|                                       |                        | T <sub>J</sub> = 125 °C |                               | 1.5    | -    |      |
|                                       | V <sub>R</sub> = 200 V | T <sub>J</sub> = 25 °C  |                               | -      | 0.25 |      |
|                                       |                        | T <sub>J</sub> = 125 °C |                               | 3      | 10   |      |
| Typical junction capacitance          | 4.0 V, 1 MHz           |                         | C <sub>J</sub>                | 700    | -    | pF   |

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: pulse width  $\leq 5\text{ ms}$ **THERMAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                  | SYMBOL                   | V40PW22C | UNIT                 |
|----------------------------|--------------------------|----------|----------------------|
| Typical thermal resistance | $R_{\theta JA}^{(1)(2)}$ | 65       | $^{\circ}\text{C/W}$ |
|                            | $R_{\theta JM}^{(3)}$    | 1.5      |                      |

**Notes**(1) The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ (2) Free air, mounted on recommended copper pad area, 2 oz., FR4 PCB; thermal resistance  $R_{\theta JA}$  - junction to ambient(3) Mounted on infinite heat sink; thermal resistance  $R_{\theta JM}$  - junction-to-mount**ORDERING INFORMATION** (Example)

| PREFERRED P/N                | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
|------------------------------|-----------------|------------------------|---------------|------------------------------------|
| V40PW22C-M3/I                | 0.20            | I                      | 4500          | 13" diameter plastic tape and reel |
| V40PW22CHM3/I <sup>(1)</sup> | 0.20            | I                      | 4500          | 13" diameter plastic tape and reel |

**Note**

(1) AEC-Q101 qualified

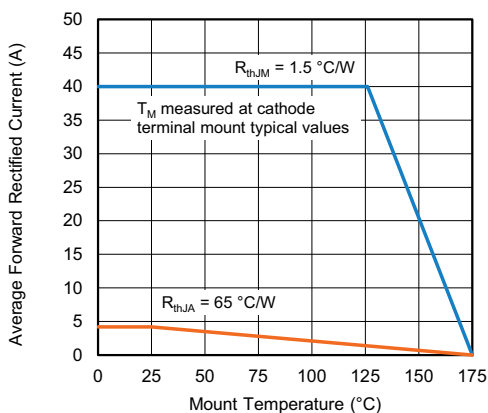
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

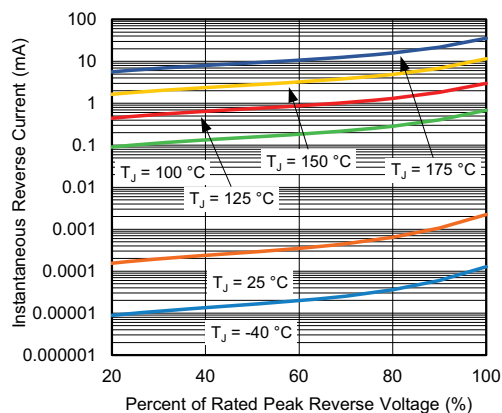


Fig. 4 - Typical Reverse Leakage Characteristics

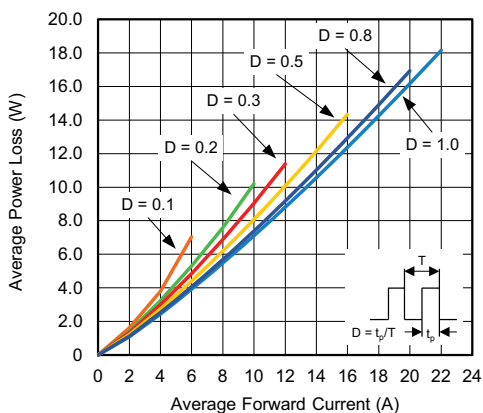


Fig. 2 - Forward Power Loss Characteristics

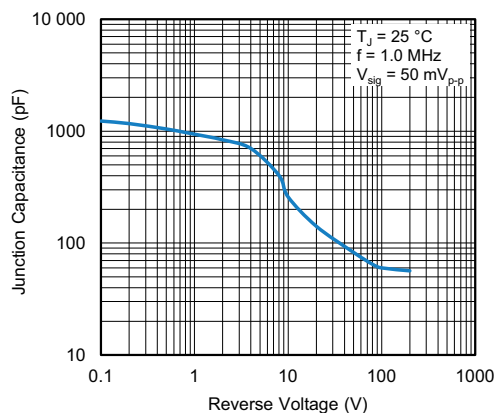


Fig. 5 - Typical Junction Capacitance

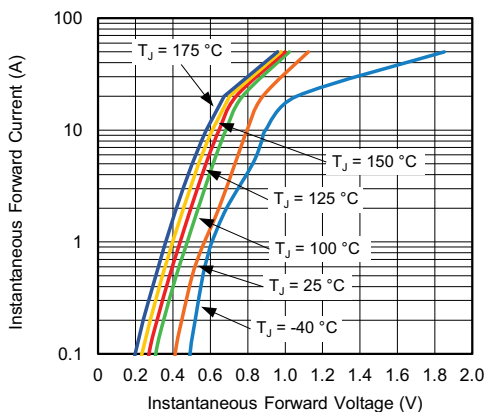


Fig. 3 - Typical Instantaneous Forward Characteristics

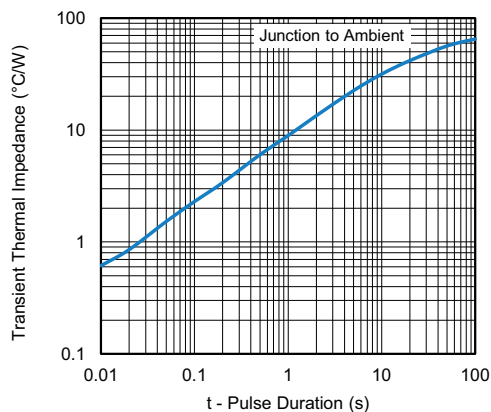


Fig. 6 - Typical Transient Thermal Impedance

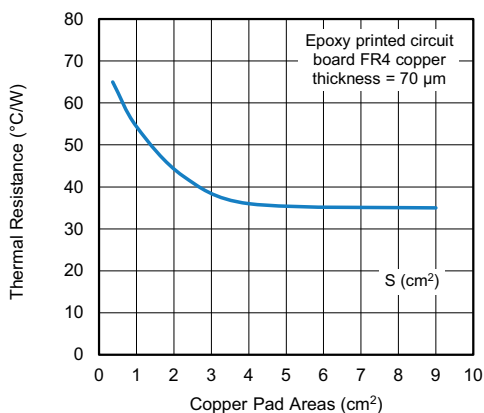
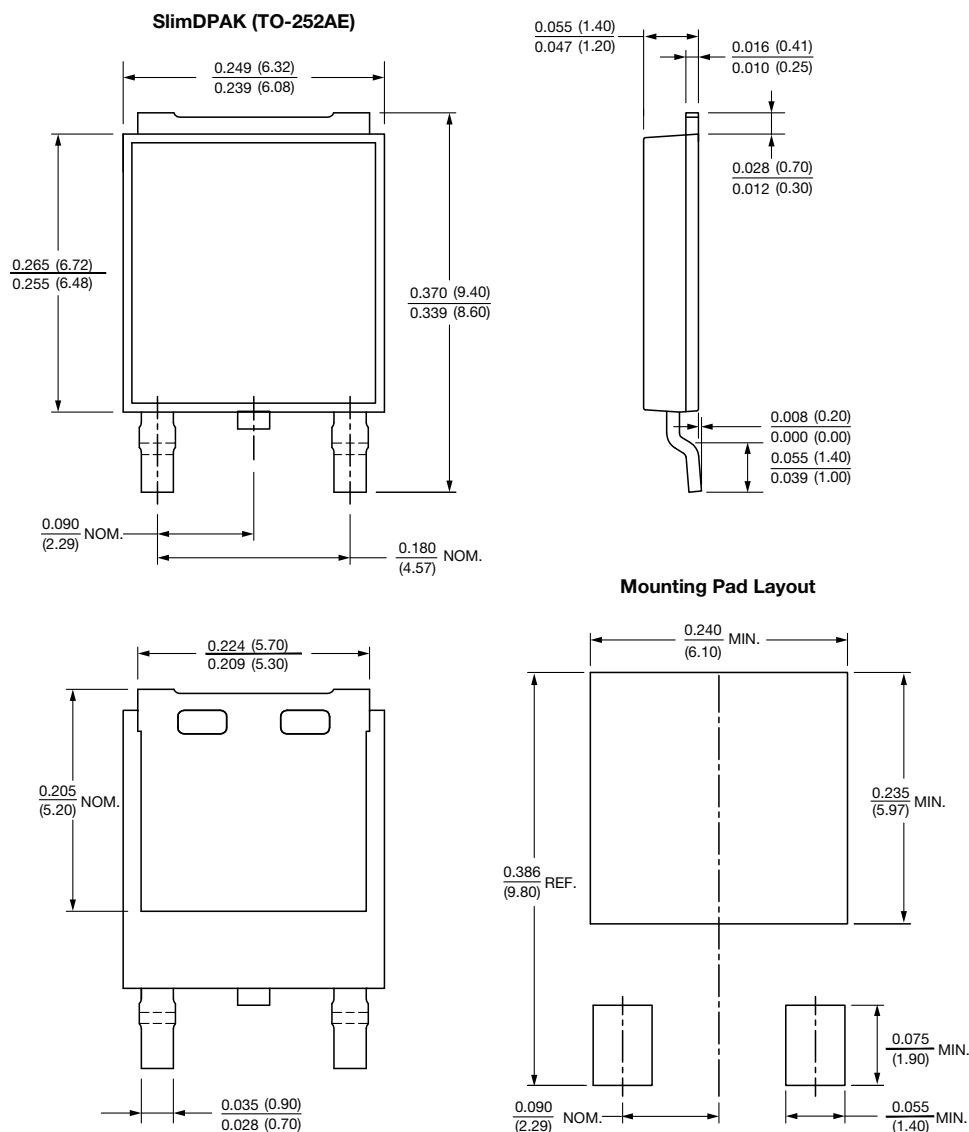


Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

### PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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